

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: **Tadahiro KURODA, et al.**

Serial Number: **Not Yet Assigned**  
(§371 of International Application PCT/JP05/02117)

Filed: **August 8, 2006**

For: **ELECTRONIC CIRCUIT**

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

August 8, 2006

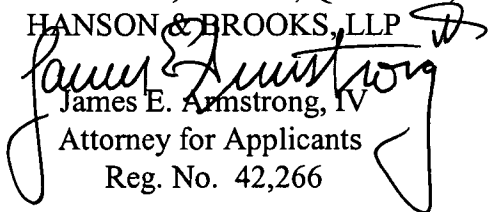
Sir:

In compliance with 37 CFR 1.56, Applicants call to the attention of the Patent and Trademark Office the references listed on the attached PTO-1449 and cited in the enclosed international search report. References AE-AF and AJ-AL are cited in the international search report.

A copy of each of the references is enclosed herewith.

In the event there are any fees due in connection with the filing of this paper, please charge Deposit Account No. 01-2340.

Respectfully submitted,  
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PATENT TRADEMARK OFFICE

Enclosures: PTO-1449; References (5); International Search Report

10/588769  
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<b>INFORMATION DISCLOSURE STATEMENT PTO-1449</b>	Atty. Docket No. 060570	Serial No. New Application
	Applicant(s): Tadahiro KURODA, et al.	
	Filing Date: August 8, 2006	Group Art Unit: Not Yet Assigned

### U.S. PATENT DOCUMENTS

Examiner Initial	Document No.	Name	Date	Class	Subclass	Filing Date (If appropriate)
_____	AA	[Diagonal line across the table]				
_____	AB					
_____	AC					
_____	AD					

### FOREIGN PATENT DOCUMENTS

Document No.	Date	Country	Translation (Yes or No)
/Y.S./	AE	2000-124406	04/28/00 Japan Yes-Abstract
/Y.S./	AF	11-68033	03/09/99 Japan Yes-Abstract/Discussed in the specification
_____	AG	[Diagonal line across the table]	
_____	AH		
_____	AI		

### OTHER DOCUMENTS

/Y.S./	AJ	K. Onizuka, et al.; "A Study on Chip-to-Chip Wireless Power Transmission;" 2003 <i>Nen The Institute of Electronics, Information and Communication Engineers Kiso • Kyokai Society Taikai Koen Ronbunshu</i> ; September 10, 2003; p. 3.				
/Y.S./	AK	K. Kanda, et al.; "1.27 Gb/s/pin, 3mW/pin Wireless Superconnect (WSC) Interface Scheme;" <i>The Institute of Electronics, Information and Communication Engineers Gijutsu Kenkyu Hokoku</i> ; Vol. 103; No. 88 (ICD2003-16); May 2003; pp. 19-22.				
/Y.S./	AL	K. Kanda, et al.; "2003 IEEE International Solid-State Circuits Conference ISSCC 2003/ Sesion 10/ High Speed Building Blocks/Paper 10.7; Vol. 1; 2003; (10 Sheets.)				
<table style="width: 100%; border: none;"> <tr> <td style="width: 20%;">Examiner</td> <td style="width: 20%;">/Yuriy Semenenko/</td> <td style="width: 20%;">Date Considered</td> <td style="width: 40%;">02/23/2009</td> </tr> </table>			Examiner	/Yuriy Semenenko/	Date Considered	02/23/2009
Examiner	/Yuriy Semenenko/	Date Considered	02/23/2009			